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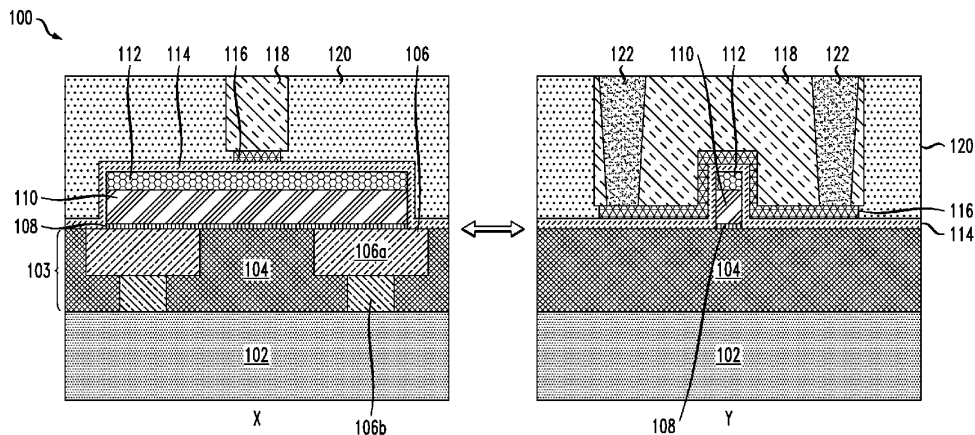
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(54) **Title:** PHASE CHANGE MATERIAL SWITCH AND METHOD OF FABRICATING SAME

FIG. 5



(57) **Abstract:** A phase change material switch includes a phase change layer disposed on a metal liner. A gate dielectric layer is disposed on the phase change layer. A metal gate liner is disposed on the gate dielectric layer.

[Continued on next page]

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